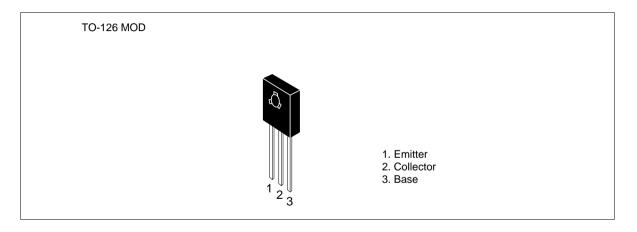
Silicon PNP Epitaxial

# HITACHI

#### Application

Low frequency power amplifier complementary pair with 2SD669/A

### Outline





## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

		Ratings		
Item	Symbol	2SB649	2SB649A	Unit
Collector to base voltage	V <sub>CBO</sub>	-180	-180	V
Collector to emitter voltage	V <sub>CEO</sub>	-120	-160	V
Emitter to base voltage	V <sub>EBO</sub>	-5	-5	V
Collector current	Ι <sub>c</sub>	-1.5	-1.5	А
Collector peak current	I <sub>C(peak)</sub>	-3	-3	А
Collector power dissipation	Pc	1	1	W
	P <sub>c</sub> *1	20	20	W
Junction temperature	Tj	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	°C

Note: 1. Value at  $T_c = 25^{\circ}C$ 

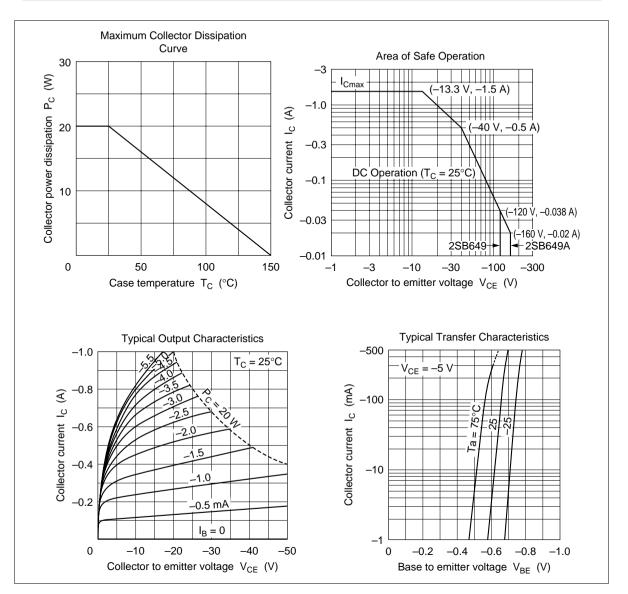
## **Electrical Characteristics** (Ta = 25°C)

		2SB6	49		2SB649A				
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\scriptscriptstyle (BR)CBO}$	-180	_	—	-180	_	_	V	$I_{c} = -1 \text{ mA}, I_{e} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-120	_	—	-160	_	_	V	$I_c = -10 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{\rm (BR)EBO}$	-5	_	—	-5	_	_	V	$I_{\rm E} = -1$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>			-10	_	_	-10	μA	$V_{CB} = -160 \text{ V}, I_{E} = 0$
DC current transfer ratio	$h_{FE1}^{*1}$	60	_	320	60	_	200		$V_{ce} = -5 V,$ $I_{c} = -150 mA$
	$h_{\text{FE2}}$	30	_	—	30	_	_		$V_{ce} = -5 V,$ $I_c = -500 \text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	_	-1	—	_	-1	V	$I_{c} = -500 \text{ mA},$ $I_{B} = -50 \text{ mA}$
Base to emitter voltage	$V_{BE}$	—	_	-1.5	—	_	-1.5	V	$V_{ce} = -5 V,$ $I_{c} = -150 mA$
Gain bandwidth product	f <sub>T</sub>	—	140	—	—	140	_	MHz	$V_{ce} = -5 V,$ $I_{c} = -150 mA$
Collector output capacitance	Cob	_	27		_	27	_	pF	$V_{CB} = -10 \text{ V}, I_E = 0,$ f = 1 MHz
Notes: 1. The 2SB649 and 2SB649A are grouped by here as follows.									

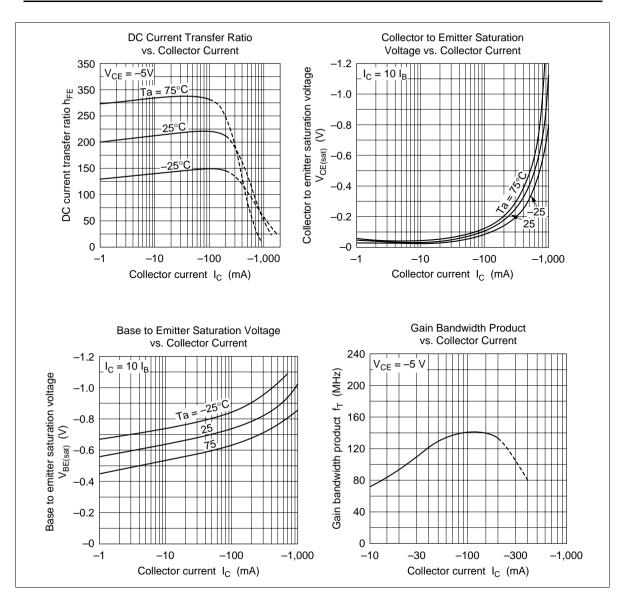
Notes: 1. The 2SB649 and 2SB649A are grouped by  $h_{\mbox{\tiny FE1}}$  as follows.

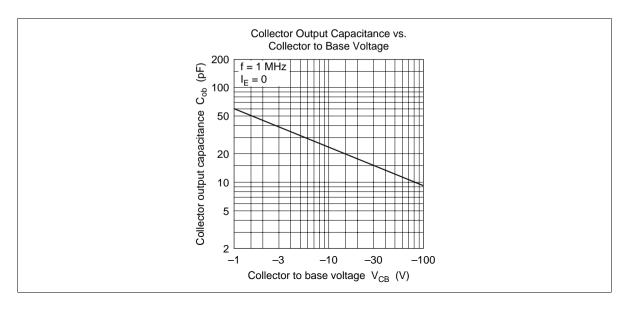
2. Pulse test

	В	С	D
2SB649	60 to 120	100 to 200	160 to 320
2SB649A	60 to 120	100 to 200	_



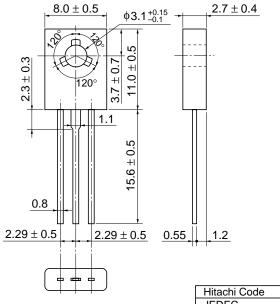
#### **HITACHI**





### HITACHI

#### Unit: mm



Hitachi Code	TO-126 Mod
JEDEC	
EIAJ	_
Weight (reference value)	0.67 g

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